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For Immediate Release

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(Securities code: 1870, TSE Prime Market, NSE Premier Market)
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Notice Regarding Submission of a Shelf Registration Statement for Corporate Bonds

YAHAGI CONSTRUCTION CO., LTD. (the "Company") hereby announces that it has submitted a shelf registration statement for corporate bonds to the Director-General of the Kanto Local Finance Bureau today. Details are as follows.

The Group is pursuing growth investments under its Medium-Term Management Plan, including real estate investment, investments in DX and information technology, human resource investment, and R&D investment. In anticipation of increased funding needs associated with the expansion of its business operations and the scale of its investments, as well as changes in the financial environment, the Group recognizes the importance of securing diverse financing options and establishing a stable and flexible financing framework.

This shelf registration is intended to secure access to the corporate bond market as an additional funding source while maintaining borrowings from financial institutions as the Group's primary source of funding. By doing so, the Group aims to enhance the stability and flexibility of its funding base and establish a framework for raising the funds needed for future growth in a timely manner. In addition, the Group will seek to expand its future funding capacity by building a track record through bond issuances and engaging in ongoing dialogue with bond investors.

An overview of the shelf registration statement is provided below.

1. Type of securities to be offered	Corporate bonds
2. Planned issuance period	The two-year period commencing on the expected effective date of the shelf registration (October 31, 2026 to October 30, 2028)
3. Planned issuance amount	10 billion yen
4. Use of proceeds	The proceeds are intended to be used for capital expenditures, repayment of borrowings, investments and loans, and working capital.

The planned issuance amount represents the maximum aggregate amount of corporate bonds that may be issued during the two-year planned issuance period. The submission of this shelf registration statement does not constitute a decision to immediately issue 10 billion yen in corporate bonds.

The Company will determine the specific terms of any future bond issuances, including the timing, issuance amounts and maturities, taking into account market conditions, funding needs and other factors.

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